SDAS096C - JANUARY 1986 - REVISED JANUARY 1995

- Functionally Equivalent to AMD's AM29863
- Power-Up High-Impedance State
- Package Options Include Plastic Small-Outline (DW) Packages and Standard Plastic (NT) 300-mil DIPs

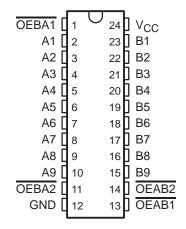
description

This 9-bit transceiver is designed for asynchronous two-way communication between data buses. The control-function implementation allows for maximum flexibility in timing.

This device allows data transmission from the A bus to the B bus or from the B bus to the A bus, depending on the logic levels at the output-enable (OEAB1, OEAB2, OEBA1, and OEBA2) inputs.

The SN74ALS29863 is characterized for operation from 0°C to 70°C.

DW OR NT PACKAGE (TOP VIEW)



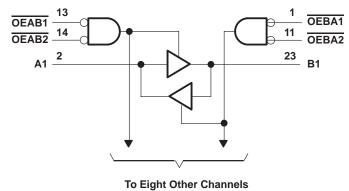
FUNCTION TABLE

	INP	OPERATION		
OEAB1	OEAB2	OEBA1	OEBA2	OPERATION
L	L	L	L	Latch A and B
L	L	Н	Х	A to B
L	L	Χ	Н	Alob
Н	Χ	L	L	B to A
Х	Н	L	L	B to A
Н	Χ	Н	Х	
Н	Χ	Χ	Н	Isolation
Х	Н	Χ	Н	isolation
Х	Н	Н	Χ	

logic symbol†

OEBA1 11 EN₁ OEBA2 13 OEAB1 EN2 14 OEAB2 23 В1 ⊲ 2 ▽ 22 3 Α2 **B2** 21 А3 **B**3 5 20 Α4 **B**4 19 Α5 **B5** 7 18 **A6 B6** 17 В7 Α7 16 **B8 A8** 10 15 A9 В9

logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage, V _{CC}	 7 V
Input voltage, V _I (all inputs and I/O ports)	 5.5 V
Operating free-air temperature range, TA	 0°C to 70°C
Storage temperature range	 -65°C to 150°C

[‡] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

		MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.75	5	5.25	V
VIH	High-level input voltage	2			V
V _{IL}	Low-level input voltage			0.8	V
ІОН	High-level output current			-24	mA
l _{OL}	Low-level output current			48	mA
TA	Operating free-air temperature	0		70	°C



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS			TYP [†]	MAX	UNIT
VIK		V _{CC} = 4.75 V,	$I_{I} = -18 \text{ mA}$			-1.2	V
Va		V _{CC} = 4.75 V	I _{OH} = -15 mA	2.4			V
VOH		VCC = 4.75 V	$I_{OH} = -24 \text{ mA}$	2			
VOL		V _{CC} = 4.75 V,	$I_{OL} = 48 \text{ mA}$		0.35	0.5	V
lį		V _{CC} = 5.25 V,	V _I = 5.5 V			0.1	mA
1	Control inputs	V F 25 V	V _I = 2.7 V			20	^
ΊΗ	A or B ports [‡]	$V_{CC} = 5.25 \text{ V}, \qquad V_{I} =$				20	μΑ
Ī	Control inputs	V	V: 0.4.V			-0.1	mA
ΊL	A or B ports‡	$V_{CC} = 5.25 \text{ V},$	V _I = 0.4 V			-0.1	IIIA
los§		V _{CC} = 5.25 V,	V _O = 0	-75		-250	mA
ICC		V _{CC} = 5.25 V			40	65	mA

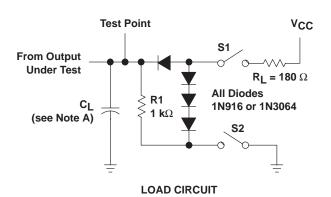
switching characteristics (see Figure 1)

PARAMETER	FROM	то	TEST CONDITIONS	V _{CC} = 4.75 \	UNIT	
PARAMETER	(INPUT)	(OUTPUT)	TEST CONDITIONS	MIN	MAX	UNIT
^t PLH	A or B	D A	0 000 = 5		15	no
^t PHL	AOIB	B or A	C _L = 300 pF		15	ns
^t PLH	A or B	D as A	A C _L = 50 pF		8	ns
t _{PHL}	AOIB	B or A			8	
^t PZH	OEAB or OEBA	A or B		20	ns	
^t PZL	OEAB OF OEBA		CL = 300 pF		23	115
^t PZH	OFAR - OFRA	A - : : D	0 50 5		15	ns
t _{PZL}	OEAB or OEBA	A or B	C _L = 50 pF		15	110
^t PHZ	OFAR - OFRA	A B	0 50 5		17	no
tPLZ	OEAB or OEBA	A or B	C _L = 50 pF		12	ns
^t PHZ	OEAB or OEBA	A or B	C _L = 5 pF		9	ns
^t PLZ	OEAD OF OEBA	AUIB			9	115

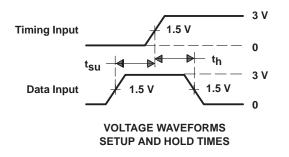


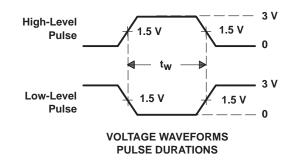
[†] All typical values are at V_{CC} = 5 V, T_A = 25°C. ‡ For I/O ports, the parameters I_{IH} and I_{IL} include the off-state output current. § Not more than one output should be shorted at a time and duration of the short circuit should not exceed one second.

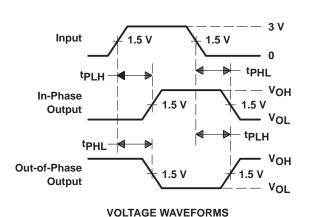
PARAMETER MEASUREMENT INFORMATION

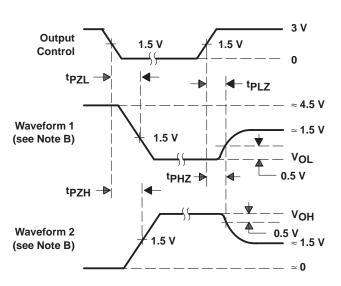


SWITCH POSITION TABLE				
TEST	S1	S2		
[†] PLH [†] PHL [†] PZH [†] PZL [†] PHZ [†] PLZ	Closed Closed Open Closed Closed Closed	Closed Closed Closed Open Closed Closed		









PROPAGATION DELAY TIMES

ENABLE AND DISABLE TIMES, 3-STATE OUTPUTS

VOLTAGE WAVEFORMS

- NOTES: A. C_L includes probe and jig capacitance.

 B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control.

 Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50 \Omega$, $t_f \leq 2.5$ ns. $t_f \leq 2.5$ ns.

Figure 1. Load Circuit and Voltage Waveforms



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